







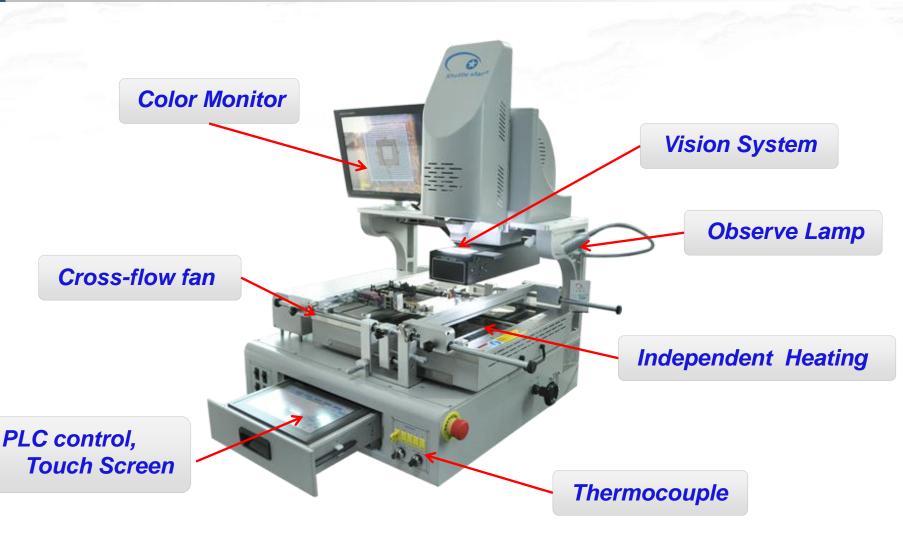
Directory

- 1. SV-650A General Introduction
- 2. SV-650A Hardware Parts
- 3. SV-650A Software Introduction
- 4. SV-650A Precision
- 5. Specification and Parameters
- 6. SV-650A Patent & Awards

1.SV-650A Profile—Parts Introduction



BGA rework station SV-650A Introduction



1.SV-650A Profile—Features



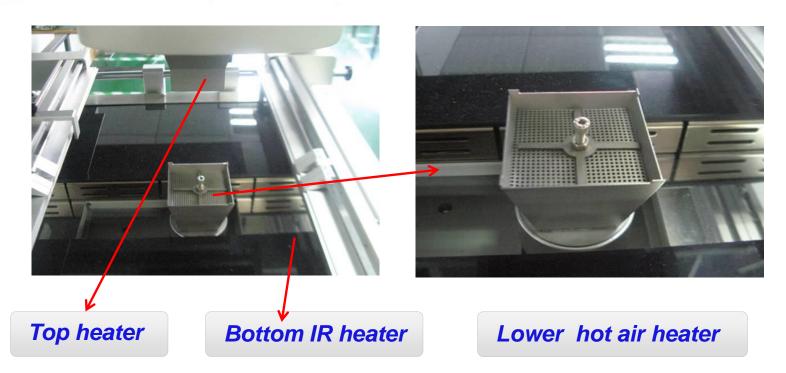
BGA rework station SV-650A Introduction

- Hot air heater head and mounting head are designed 2 in 1, driven by step electric motor, have both the auto soldering and mounting function;
- Three heaters(upper/lower hot air heater, bottom IR heater) heating independently, time and temperature can be displayed digitally on touch screen;
- Upper heater used the auto cooling and heating device, temp be controlled precision and uniform;
- Bottom preheating used the imported IR heating tube, with high temperature glass, which makes heating and cooling quickly, set process curve precisely and the whole piece of PCB deformation, easy to solder, energy conservation and environmental protection;
- Large movable bottom IR heating area, PCB clamps can be adjusted along with X & Y table flexibly, the max PCB size it can handle up to 540*450mm;
- Color optical system with functions of split vision, zoom in/out and micro-adjust, equipped with aberration detection device; with auto focus and software operation function, 1.3 million pixels high definition camera, 18 x optical zoom;
- Embedded industrial computer, touch screen interface, PLC control, real-time profile display, able to display set profile and 5 practically tested profile at the same time; can analyze the five practically-tested profiles;
- High-definition color LCD monitor;
- **B** Built-in vacuum pump, 60 ° rotation in φ angle, mounting nozzle is micro-adjustable;
- 8 segments of temperature up(down) and 8 segments constant temperature control, profile saving is unlimited in the industrial computer;
- Suction nozzle can identify material and mounting height automatically, and can control the air pressure within a small range of 30-50g;
- Can automatic absorption and putting the material, automatic solder, placement and welding;
- Equipped with different hot air nozzles, easy to replace and able to locate in any angle.





Heating system: Three independent temperature zones, (top hot air heating, under hot air heating, and bottom IR heating), temperature and time can be displayed digitally on the touch screen, able to rework **BGA**







Nozzle: Different-sized nozzles for different-sized BGAs, for particular component, nozzle can be custom-made.

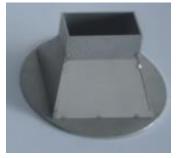




28x28mm



38x38mm



44x28mm



31x31mm



18x8mm



24x24mm



7x7mm

2.SV-650A Hardware—Alignment & Placement System

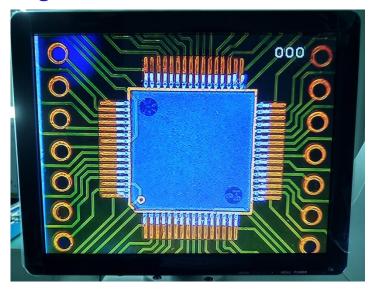


BGA rework station SV-650A Introduction

Alignment & placement: Mega pixels, high-definition color optical vision system, with functions of spectral, amplification and fine-tuning, including color difference distinguish device, automatic focus, software operation function, applying the prism optical principle to make both up and down image clear and accurate.



Can be automatically counterpoint, easy and flexibly to operate



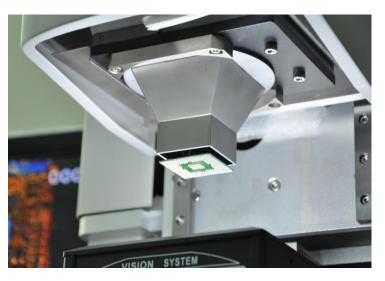
Blue image for IC, yellow image for PCB





Hot air head and mounting head are designed 2 in 1, and have both the auto soldering and mounting function, easy to operate.





SV-650A BGA placement

SV-650A BGA Removal





Pressure from the suction to the IC can be micro-adjusted, minimum pressure less than 30g,ensure BGA not leak lead while heating.





Pressure testing



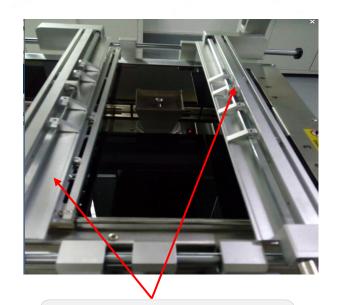


Suction nozzles in package





Clamping device: Specially designed with flexibly-moving clamping device to clamp all kinds of PCB, also equipped with particular clamps for laptop motherboard



flexibly-moving clamping device



Particular clamps for laptop motherboard





Clamping device: Clamps installing schematic diagram; the irregular PCB like laptop motherboard can be grasped flatly by the clamps.



Installing diagram



Clamping diagram

2.SV-650A Hardware—Clamping Device



BGA rework station SV-650A Introduction

Clamping device: Special anti-warpage design, the support pillars can be adjusted up & down to support the board to prevent the PCBA from sinking while heating.



Anti- warpage support working diagram

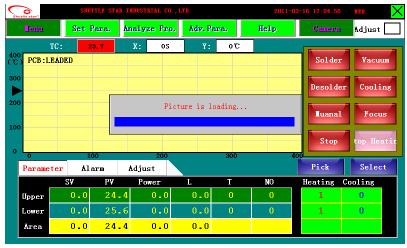


3.SV-650A Software Introduction—Adjustment Interface

BGA rework station SV-650A Introduction

Control interface: RW-SV650A with touch screen interface, PLC control; able to display real-time temperature curves and detecting temperature curves at the same time





Startup screen

Main operation screen



3.SV-650A Software Introduction—Adjustment Interface

BGA rework station SV-650A Introduction

Adjustment interface: Able to arrive at three independent temperature zones, temperature and time can be displayed digitally on the touch screen, 8 segments of temperature up (down) and 8 segments constant temperature control, more than 50000 groups of profile can be stored.



PCB: PCB SUIL: NO. Name down NO. Name up LEADED 11 LEADED FREE 12 3 13 14 5 15 16 17 18 9 19 10 20 Page: NO.: Down Delete Load Close

Parameter Setting

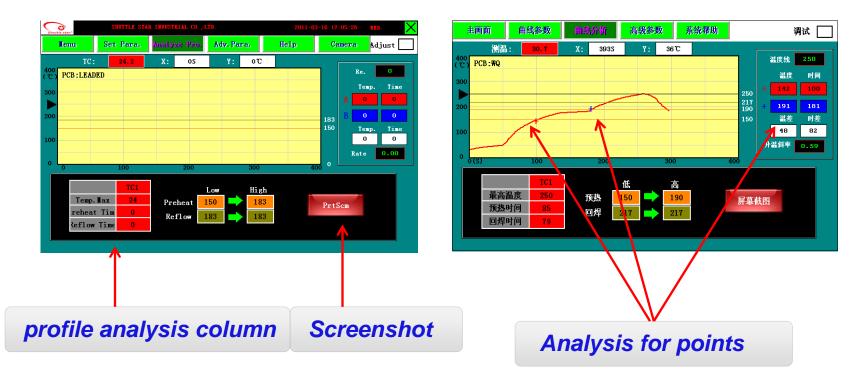
Profile Name Setting



3.SV-650A Software Introduction—Analysis Interface

BGA rework station SV-650A Introduction

Analysis interface: able to display 1 practically-tested temperature curve at the same time, and auto-calculate the preheat time, reflow time and max temp, so to control temp. of every point of BGA overall; can create profile for every kind of BGA accordingly.





3.SV-650A Software Introduction—Instant Regulation

BGA rework station SV-650A Introduction

Instant regulation: During heating, if find the TC temperature too low or too high, parameters can be changed while it is heating under the Instant Regulation function to avoid repeat heating.



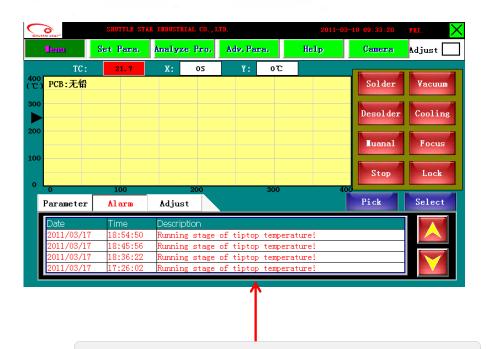
Click "L" or "T"in the down column to change parameters while heating



3.SV-650A Software Introduction—Alarm Interface

BGA rework station SV-650A Introduction

Alarm Interface: Under this menu, it points out troubles and error while machine is working. By this caution, we may know what problem the machine faces and make quick trouble shooting.

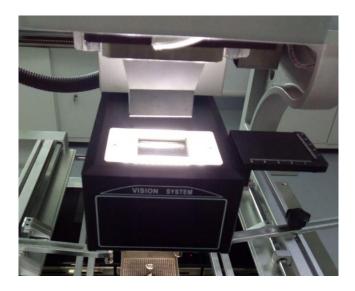


Abnormal alarm event description

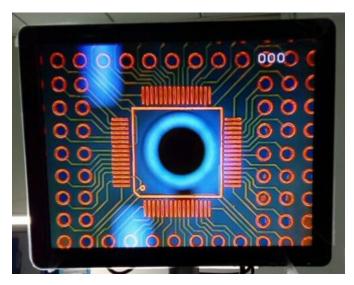




Optical Alignment System: Mega pixels, high-definition color optical vision system, with functions of spectral, amplification and fine-tuning, including color difference distinguish device, automatic focus, software operation function, able to rework BGA sized up to 80mm*80mm



Alignment through camera



Color image in display





Alignment accuracy: automatic servo system controls BGA placement, desolder and solder; placement accuracy reaches 0.01mm, which is suitable for the smallest IC with pitch of 0.15mm









Placement

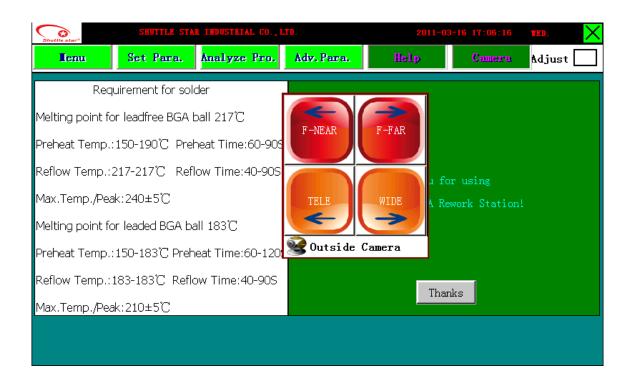


4.SV-650A Accuracy Testing —Placement Accuracy



BGA rework station SV-650A Introduction

Color optical system with functions of split vision, zoom in/out and micro-adjust, equipped with aberration detection device; with auto focus and software Operation function, 22 X optical focus







PCB & Component Requirements	
Max.PCB size	540mm x450mm
Max.PCB thickness	0.5~4mm
Max.BGA size	80mm x 80mm
Min.BGA size	4mm x 4mm
Max. BGA weight	80g
Vision System Specifications	
Max. visible area	40mm x 40mm
Min. Pitch	/0.15mm
Micrometer Adjust Range	Front/Rear ± 5mm Left/Right ± 5mm
Rotation Angle	360°
Thermal Specifications	
Max.temp.for hot-air heater	350° C
Max.temp.for IR heater	400° C
Temperature control	8-Stage Programmable Temperature Settings
Upper heater power	1200W
lower heater power	800W
Bottom IR heater power	3600W
Dimensions & Power Requirements	
Machine dimension	746mm (L) 710mm (W) 820mm (H)
Weight	Appox 90Kg
Power Requirements	Single Phase, 220VAC, 50/60 Hz,

6.SV-650A Patent & Awards



BGA rework station SV-650A Introduction







Thanks for your time!

深圳市效时科技有限公司 SHENZHEN SHUTTLE STAR TECHNOLOGY CO., LTD.

Phone: +86 18165724375

Tel: +86-755- 27512579

Fax: +86-755-27513966

Website: www.shuttlestar.cn

E-mail: assistant@shuttlestar.cn